# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
WEN-TSUNG HUANG	10/02/2018

### **RECEIVING PARTY DATA**

Name:	REALTEK SEMICONDUCTOR CORPORATION	
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Postal Code:	300	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	16161518	

### **CORRESPONDENCE DATA**

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SIGNATURE:	/Justin King/
DATE SIGNED:	10/16/2018

**Total Attachments: 1** 

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PATENT 505143538 REEL: 047179 FRAME: 0053

# **ASSIGNMENT**

WHEREAS, I(we), WEN-TSUNG HUANG whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled.

## Defective pixel compensation method and device

(hereinafter referred to as the INVENTION) for which an a is executed on even date herewith unless at least one of t United States Design Patent was executed on:		
☐ filed on: Serial No.: ☐ established by PCT International Patent Applicate United States of America ☐ issued on		
WHEREAS, REALTEK SEMICONDUCTOR CORP Innovation Road II, Hsinchu Science Park, Hsinchu 3 is desirous of acquiring the entire right, title and interest possessions;	ORATION whose post 100, Taiwan (R.O.C.) l	office address is No. 2, nereinafter referred to as ASSIGNEE,
NOW, THEREFORE, for good and valuable consid ASSIGNOR, by these presents do sell, assign and transfer and to said INVENTION and application throughout the Patent granted on any division, continuation, continuation terms for which the same may be granted, including all p	unto said ASSIGNEE, United States of Amen- n-in-part and reissue of	the entire right, title, and interest in crica, including any and all Letters said application for the full term of
ASSIGNOR further covenants that no assignments, or entered into which would conflict with this Assignment		umbrance has been or will be made
ALSO, ASSIGNOR hereby agrees to execute any doct filing, prosecution and maintenance of said application said INVENTION, including additional documents that m said INVENTION, all without further consideration. AS ASSIGNEE'S expense, to identify and communicate to AS concerning the INVENTION that are within ASSIGNOR'S p testimony on behalf of ASSIGNEE that lawfully may maintenance, litigation and defense of any patent app instrument. ASSIGNOR'S obligations under this ins administrators and other legal representatives.	or any other patent apy ay be required to affirm SIGNOR also agrees, we signed at Assignee's cossession or control, at the required of Assigned lication or patent encountered.	plication(s) in the United States for m the rights of ASSIGNEE in and to without further consideration and a request documents and information and to provide further assurances and NOR in respect of the prosecution compassed within the terms of this
ALSO, ASSIGNOR hereby authorizes and requests the and all Letters Patent referred to above to ASSIGNEE, as the same, for ASSIGNEE'S sole use and behoof; and for the successors, to the full end of the term for which such I same would have been held by ASSIGNOR had this assign	the ASSIGNEE of the en ne use and behoof of A Letters Patent may be g	itire right, title and interest in and to SSIGNEE'S legal representatives and granted, as fully and entirely as the
ASSIGNOR NAME WEN-TSUNG HUANG	Address No.239, Ln. 17, F City 600, Taiwan (	ang'an Rd., East Dist., Chiayi R.O.C.)
Signature of Assignor	Date of Signature October 2,	7018
Name of Witness (optional)	Name of Witness (option	
Signature of Witness (optional)	Signature of Witness (Op	tional)

**RECORDED: 10/16/2018** 

PATENT REEL: 047179 FRAME: 0054